# 2SC3704

### Silicon NPN epitaxial planar type

For UHF band low-noise amplification

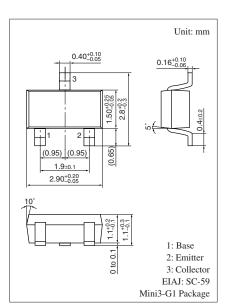
#### Features

- Low noise figure NF
- High forward transfer gain  $|S_{21e}|^2$
- $\bullet$  High transition frequency  $f_{\rm T}$
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

	pac	king

<b>The solute maximum matrices</b> $r_a = 25$ C								
Symbol	Rating	ing Unit						
V <sub>CBO</sub>	15	V						
V <sub>CEO</sub>	10	V						
V <sub>EBO</sub>	2	V						
I <sub>C</sub>	80	mA						
P <sub>C</sub>	200	mW						
Tj	150	°C						
T <sub>stg</sub>	-55 to +150	°C						
	Symbol V <sub>CBO</sub> V <sub>CEO</sub> V <sub>EBO</sub> I <sub>C</sub> P <sub>C</sub> T <sub>j</sub>	Symbol Rating   V <sub>CBO</sub> 15   V <sub>CEO</sub> 10   V <sub>EBO</sub> 2   I <sub>C</sub> 80   P <sub>C</sub> 200   T <sub>j</sub> 150						

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



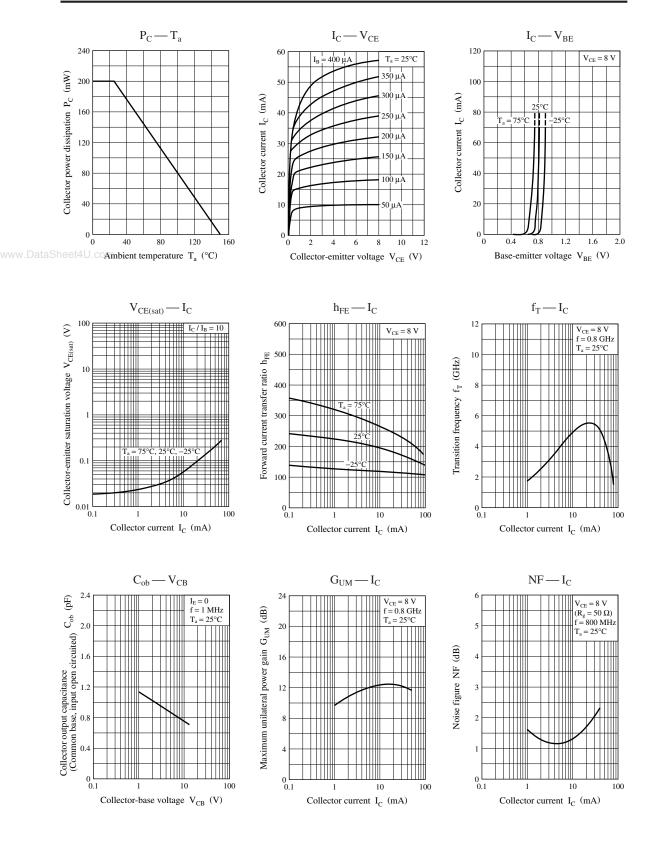
#### Marking Symbol: 2W

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 15 \text{ V}, I_E = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 1 V, I_C = 0$			1	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 8 V, I_C = 20 mA$	50	150	300	_
	h <sub>FE2</sub>	$V_{CE} = 1 V, I_C = 3 mA$	80		280	
Transition frequency	f <sub>T</sub>	$V_{CE} = 8 \text{ V}, I_C = 20 \text{ mA}, f = 0.8 \text{ GHz}$		6		GHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		0.7	1.2	pF
Forward transfer gain	$ S_{21e} ^2$	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}, f = 0.8 \text{ GHz}$		13		dB
Maximum unilateral power gain	G <sub>UM</sub>	$V_{CE} = 8 V, I_C = 20 mA, f = 0.8 GHz$		14		dB
Noise figure	NF	$V_{CE} = 8 V, I_C = 7 mA, f = 0.8 GHz$		1.0	1.7	dB

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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